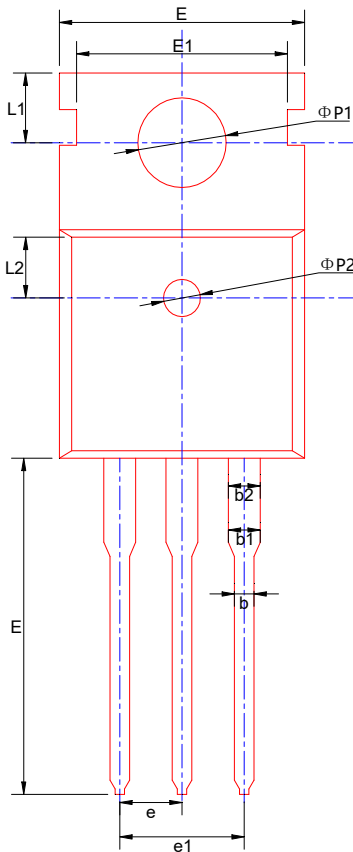
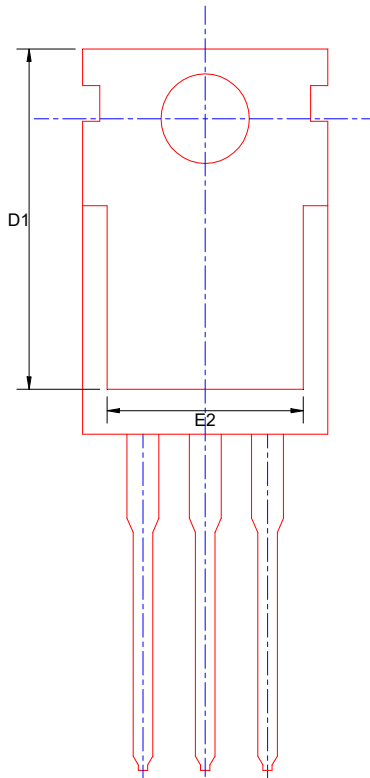


	深圳市锐骏半导体有限公司 ShenZhen Ruichips Semiconductor CO.,LTD	编号	RU-001-T0220-A-001
	封装外形尺寸（POD）规范	版本	A/0
		页次	16

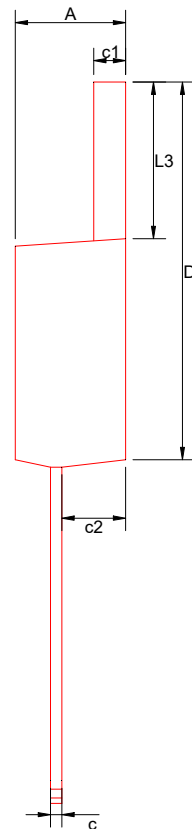
T0220



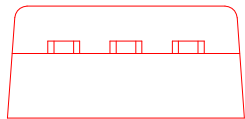
TOP VIEW
正视图



DORSAL VIEW
背视图



SIDE VIEW
侧视图



SIDE VIEW
侧视图

NOTE:

1: ALL UNITS ARE IN MILLIMETER.

2: EJECTOR PIN MARK POSITION MAY VARY FROM DIFFERENT MOLD.

SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	4.300	4.500	4.700	0.169	0.177	0.185	E1	8.600	8.700	8.800	0.339	0.343	0.346
b	0.700	0.800	0.900	0.028	0.031	0.035	E2	7.800	8.000	8.200	0.307	0.315	0.323
b1	1.170	1.270	1.370	0.046	0.050	0.054	e1	4.880	5.080	5.280	0.192	0.200	0.208
b2	1.170	1.270	1.370	0.046	0.050	0.054	L	12.950	13.150	13.350	0.510	0.518	0.526
c	0.400	0.500	0.600	0.016	0.020	0.024	L1	2.700	2.800	2.900	0.106	0.110	0.114
c1	1.250	1.300	1.350	0.049	0.051	0.053	L2	2.250	2.350	2.450	0.089	0.093	0.096
c2	2.200	2.400	2.600	0.087	0.094	0.102	L3	6.300	6.500	6.700	0.248	0.256	0.264
D	15.400	15.600	15.800	0.606	0.614	0.622	∅P1	3.500	3.600	3.700	0.138	0.142	0.146
D1	12.900	13.100	13.300	0.508	0.516	0.524	∅P2	1.350	1.500	1.650	0.053	0.059	0.065
E	9.800	10.000	10.200	0.386	0.394	0.402	e	2.54BSC			0.10BSC		